

### **MAAL-011158-DIE**

Rev. V3

#### Features

- Phase Noise: -172 dBc/Hz @ 10 kHz
- Gain: 12 dB
- P<sub>SAT</sub>: +24 dBm
- Bias Voltage:  $V_{CC}$  = +6 V
- Bias Current: I<sub>CQ</sub> = 135 mA
- 50  $\Omega$  Matched Input and Output
- Positive Voltage Only
- Die Size: 3000 x 1300 x 100 µm
- RoHS\* Compliant

### Applications

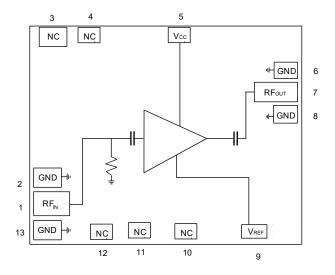
- Radar
- Electronic Countermeasures
- Test and Measurement
- Microwave Communication Systems

#### Description

The MAAL-011158-DIE is an easy to use low phase noise amplifier chip. It operates from 2 - 28 GHz and provides -172 dBc/Hz phase noise, 12 dB gain and +24 dBm  $P_{SAT}$ . The input and output are fully matched to 50  $\Omega$  with typical return loss >14 dB.

This product is fabricated using a GaAs HBT process which features full passivation for enhanced reliability.

### **Functional Schematic**



### Pad Configuration<sup>1</sup>

Pad #	Pad Name	Description
2,6,8,13	GND	DC + RF Ground to Backside Via
1	RF <sub>IN</sub>	RF Input
3,4,10,11,12	NC	Not Connected
5	V <sub>CC</sub>	Supply Voltage
7	RF <sub>OUT</sub>	RF Output
9	V <sub>REF</sub>	Reference Voltage

1. Backside of die must be connected to RF, DC and thermal ground.

#### **Ordering Information**

Part Number	Package	
MAAL-011158-DIE	Gel Pack	

\* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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# Electrical Specifications: Freq. = 2 - 28 GHz, $T_A$ = +25°C, $V_{CC}$ = 6 V, $Z_0$ = 50 $\Omega$ (Based on probed die production data)

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Gain	P <sub>IN</sub> = -10 dBm, 6 GHz P <sub>IN</sub> = -10 dBm, 18 GHz P <sub>IN</sub> = -10 dBm, 28 GHz	dB	10 10 8	12 12 10	
Gain Flatness		dB	—	±1	
Gain Variation over Temperature		dB/°C	—	0.011	—
Output Power	P <sub>IN</sub> = +13 dBm, 6 GHz P <sub>IN</sub> = +10 dBm, 18 GHz P <sub>IN</sub> = +8.5 dBm, 28 GHz	dBm	22 19 15	24 21 17.5	_
Noise Figure		dB	_	4.0	—
Input Return Loss		dB	_	15	
Output Return Loss		dB		14	_
P1dB	16 GHz	dBm		22	
P <sub>SAT</sub>	16 GHz	dBm	_	25	_
OIP3	16 GHz, -10 dBm P <sub>IN</sub> per tone	dBm		32.5	
Phase Noise	10 GHz, Psat 100 Hz 1 kHz 10 kHz 1 MHz	dBc/Hz	_	-148 -164 -172 -178	
lcq	—	mA		135	

### Absolute Maximum Ratings<sup>2,3</sup>

Parameter	Absolute Maximum	
Input Power	19 dBm	
V <sub>CC</sub>	7.5 V	
I <sub>CC</sub>	350 mA	
Junction Temperature <sup>4,5</sup>	+130°C	
Operating Temperature	-40°C to +85°C	
Storage Temperature	-65°C to +125°C	

2. Exceeding any one or combination of these limits may cause permanent damage to this device.

- 3. MACOM does not recommend sustained operation near these survivability limits.
- Operating at nominal conditions with T<sub>J</sub> ≤ +130°C will ensure MTTF > 1 x 10<sup>6</sup> hours.
- 5. Junction Temperature  $(T_J) = T_C + \Theta jc^* (V^* I)$ Typical thermal resistance  $(\Theta jc) = 16.4 \text{ °C/W}$ . a) For  $T_C = +25^\circ\text{C}$ ,  $T_J = 59.4^\circ\text{C}$  @ 7.5 V, 280 mA b) For  $T_C = +85^\circ\text{C}$ ,  $T_J = 119.4^\circ\text{C}$  @ 7.5 V, 280 mA

#### **Maximum Operating Conditions**

Parameter	Maximum	
Input Power	17 dBm	
V <sub>CC</sub>	7 V	
I <sub>CC</sub>	280 mA	
Junction Temperature	+130°C	
Operating Temperature	-40°C to +85°C	
Storage Temperature	-65°C to +125°C	

#### Handling Procedures

Please observe the following precautions to avoid damage:

#### **Static Sensitivity**

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1A, 250 V devices.

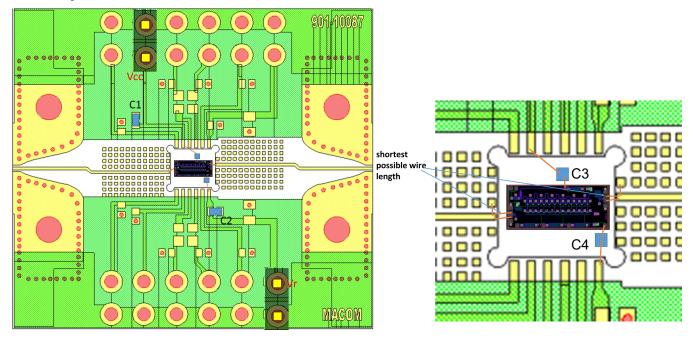
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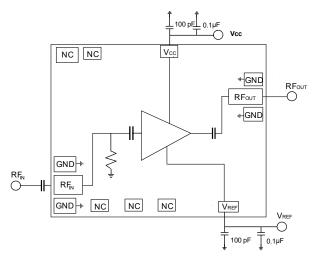
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### **PCB** Layout



### **Application Schematic**



### Operation

To turn-on:

- 1. Apply +6 V to V<sub>CC</sub>
- 2. Starting at 0 V, adjust V<sub>REF</sub> for target I<sub>CC</sub> (+2 V typical)
- To turn-off:
- 1. Set  $V_{REF}$  to 0 V
- 2. Set  $V_{CC}$  to 0 V

### **Evaluation PCB Specifications**

*Top Layer:* 1/2 oz Copper Cladding, 0.017 mm thickness *Dielectric Layer:* Rogers RO4350B 0.101 mm thickness *Bottom Layer:* 1/2 oz Copper Cladding, 0.017 mm thickness *Finished overall thickness:* 0.135 mm

### Parts List

Part	Value	Case Style	MFG	MFG Part #
C3, C4	100 pF	Single Layer	МАСОМ	MKVC-050100-1453
C1, C2	0.1 µF	0402	KYOCERA	04023C103KAT2A

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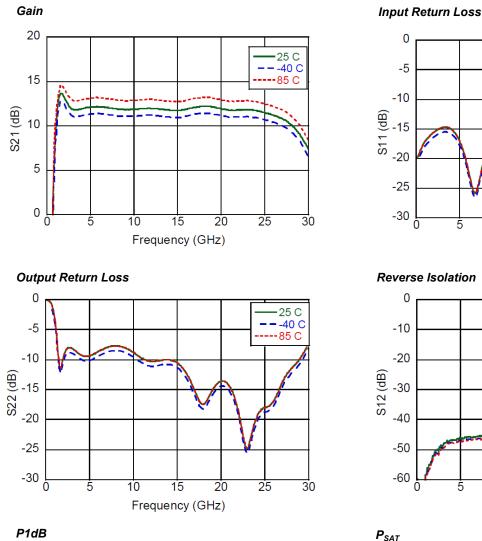
25 C

**- -** -40 C

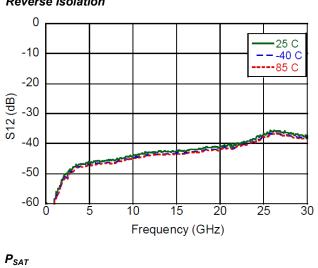
----85 C

25

30



### Typical Performance Curves: $V_{cc} = 6 V$ , $I_{cc} = 135 mA$



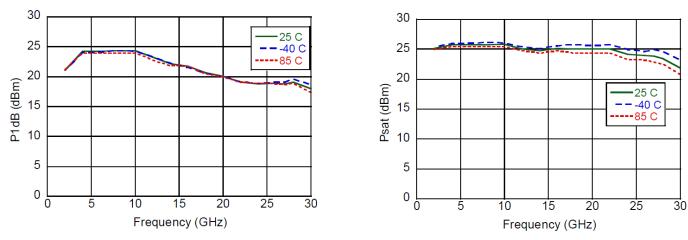
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10

15

Frequency (GHz)

20



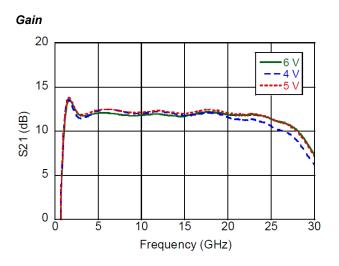
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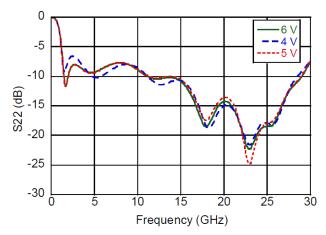


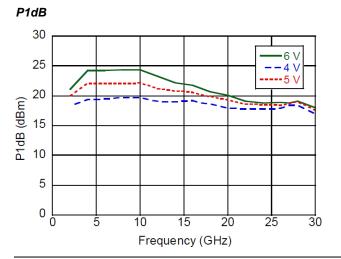
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### Typical Performance Curves: I<sub>cc</sub> = 135 mA, +25°C

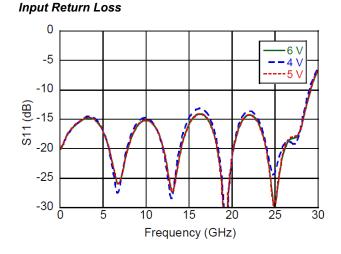


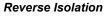
**Output Return Loss** 

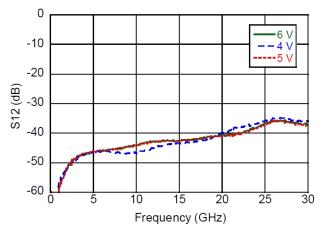


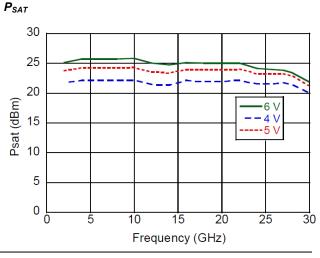








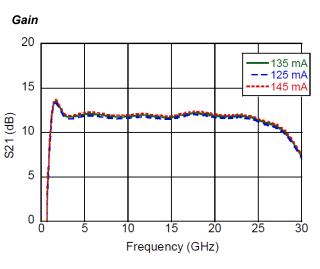




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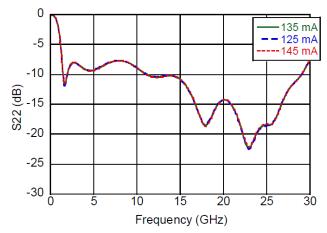


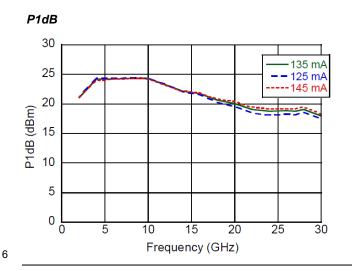
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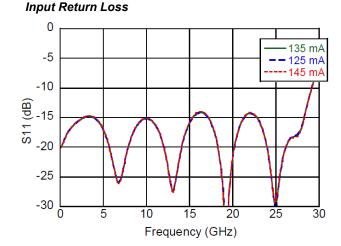


Typical Performance Curves: V<sub>cc</sub> = 6 V, +25°C

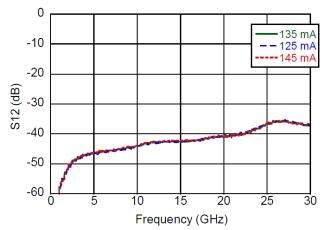
**Output Return Loss** 

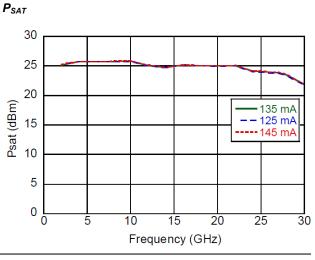






**Reverse Isolation** 





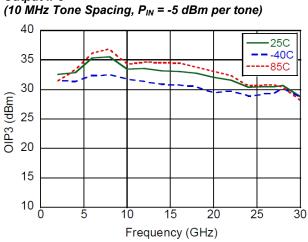
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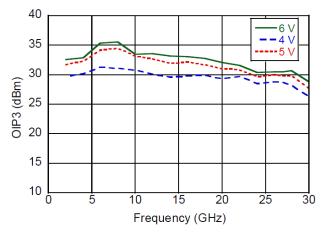
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### Typical Performance Curves: V<sub>cc</sub> = 6 V, I<sub>cc</sub> = 135 mA, +25°C

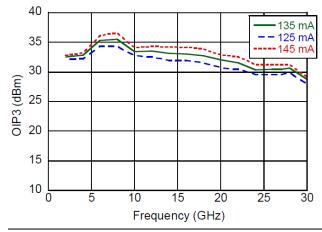
Output IP3

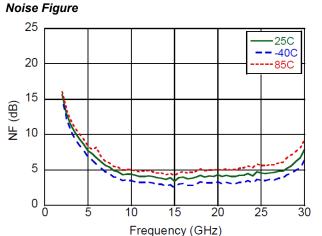


Output IP3 (10 MHz Tone Spacing,  $P_{IN} = -5 \text{ dBm per tone}$ )

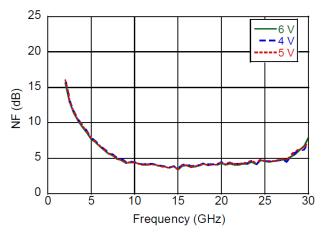


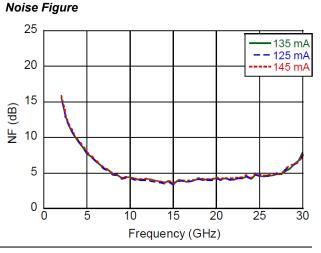
Output IP3 (10 MHz Tone Spacing,  $P_{IN}$  = -5 dBm per tone)





Noise Figure



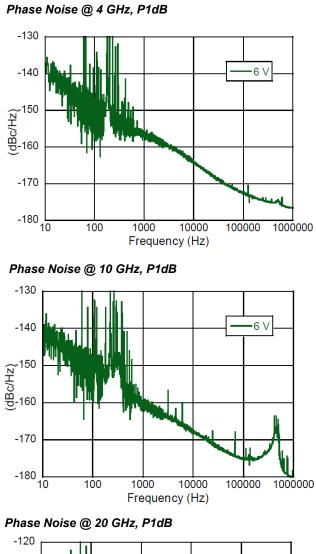


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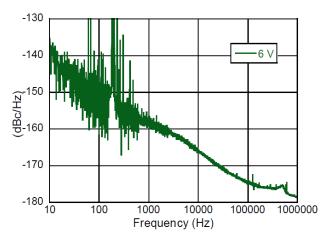


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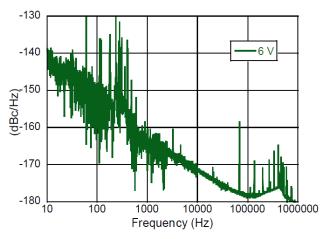




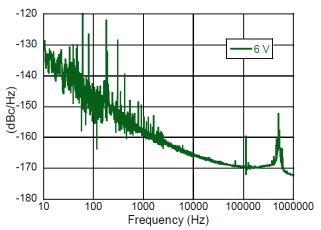
-120 -130 -140 -140 -140 -140 -150 -160 -170 -180 10 100 1000 10000 100000 Frequency (Hz) Phase Noise @ 4 GHz, P4dB



Phase Noise @ 10 GHz, P3dB







8. The aberration in the phase noise data at approximately 500 MHz is due to the test equipment used and not the amplifier itself.

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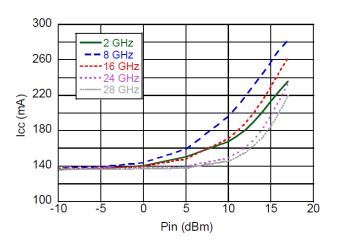


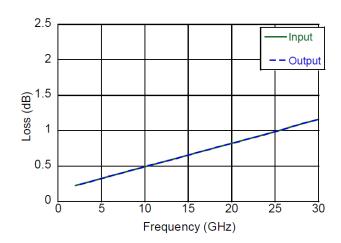
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#### **Bias Current vs Input Power**





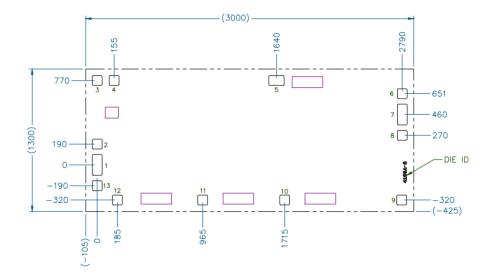


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**MMIC Die Outline** 



BONDPAD DETAIL			
PAD	SIZE(x)	SIZE(y)	
1,7	100	200	
2,3,4,6,8,9, 10,11,12,13	100	100	
5	150	100	

- NOTES: 1. UNLESS OTHERWISE SPECIFIED, ALL DIMENSIONS SHOWN ARE  $\mu$ m WITH A TOLERANCE OF  $\pm 5 \mu$ m. 2. DIE THICKNESS IS 100  $\pm 10 \mu$ m 5. DOI: THICKNESS IS 100  $\pm 10 \mu$ m
- 2. 3.
- BOND/PAD BACKSIDE METALLIZATION: GOLD DIE SIZE REFLECTS FINAL DIMENSIONS. 4.



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